

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10056667	10/29/2001	420	561	1742	Ip

**APPLICANTS: Hwang Jennie;

BEST AVAILABLE COPY

**CONTINUING DATA VERIFIED:

THIS APPLN CLAIMS BENEFIT OF 60/244,506 10/31/2000

AND CLAIMS BENEFIT OF 60/243,796 10/27/2000 *

(*)Data provided by applicant is not consistent with PTO records.

** FOREIGN APPLICATIONS VERIFIED:

PG-PUB DO NOT PUBLISH ☐

RESCIND ☐

Foreign priority claimed ☐ yes ☐ no

35 USC 119 conditions met ☐ yes ☐ no

Verified and Acknowledged Examiners's initials

ATTORNEY DOCKET NO

RJM 2 0062

TITLE : Lead-free solder compositions

U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED

CLAIMS ALLOWED

Assistant Examiner

Total Claims

Print Claim for
O.G.

ISSUE FEE

Amount Due

Date Paid

DRAWING

Sheets Drwg.

Figs. Drwg.

Print Fig.

Primary Examiner

PREPARED FOR ISSUE

Application Examiner



TERMINAL

DISCLAIMER

WARNING: The information disclosed herein may be restricted.
Unauthorized disclosure may be prohibited by the United States Code Title 35,
Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark
Office is restricted to authorized employees and contractors only.

FILED WITH:

☐ DISK (CRF)

☐ CD-ROM

(Attached in pocket on right inside flap)